MOSFET - Power, Dual N-Channel, DUAL SO-8FL

60 V, 29.7 mΩ, 19 A

NVMFD030N06C

Features

- Small Footprint (5x6 mm) for Compact Design
- Low R_{DS(on)} to Minimize Conduction Losses
- Low Q_G and Capacitance to Minimize Driver Losses
- NVMFWD030N06C Wettable Flank Option for Enhanced Optical Inspection
- AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

Typical Applications

- Power Tools, Battery Operated Vacuums
- UAV/Drones, Material Handling
- BMS/Storage, Home Automation

MAXIMUM RATINGS (T_J = $25^{\circ}C$ unless otherwise stated)

	- (-)					
Para	Symbol	Value	Units			
Drain-to-Source Voltage			V _{DSS}	60	V	
Gate-to-Source Voltage			V _{GS}	±20	V	
Continuous Drain	Steady State	$T_{C} = 25^{\circ}C$	۱ _D	19	А	
Current R _{θJC} (Notes 1, 3)	Sidle	T _C = 100°C		13		
Power Dissipation			PD	23	W	
$R_{\theta JC}$ (Note 1)	State	$T_{C} = 100^{\circ}C$		11		
Continuous Drain	Steady State	T _A = 25°C	I _D	7	А	
Current R _{θJA} (Notes 1, 2, 3)	Slale	T _A = 100°C		5		
Power Dissipation	Steady	$T_A = 25^{\circ}C$	PD	3.2	W	
$R_{\theta JA}$ (Notes 1, 2)	State	State T _A = 100°C		1.6		
Pulsed Drain Current	T _A = 25°0	C, t _p = 10 μs	I _{DM}	63	А	
Operating Junction and Storage Temperature Range			T _J , T _{stg}	–55 to +175	°C	
Source Current (Body Diode)			۱ _S	19	А	
Single Pulse Drain-to-Source Avalanche Energy ($I_L = 4.4 A_{pk}$)			E _{AS}	10	mJ	
Lead Temperature Soldering Reflow for Soldering Purposes (1/8" from case for 10 s)			ΤL	260	°C	
			•			

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.

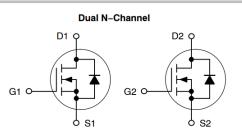
- 2. Surface-mounted on FR4 board using a 650 mm², 2 oz. Cu pad.
- 3. Maximum current for pulses as long as 1 second is higher but is dependent on pulse duration and duty cycle.

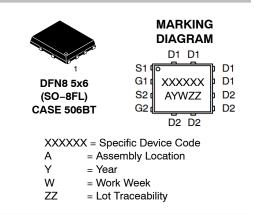


ON Semiconductor®

www.onsemi.com

V _{(BR)DSS}	R _{DS(ON)} MAX	I _D MAX
60 V	29.7 mΩ @ 10 V	19 A





ORDERING INFORMATION

See detailed ordering, marking and shipping information on page 5 of this data sheet.

THERMAL RESISTANCE RATINGS

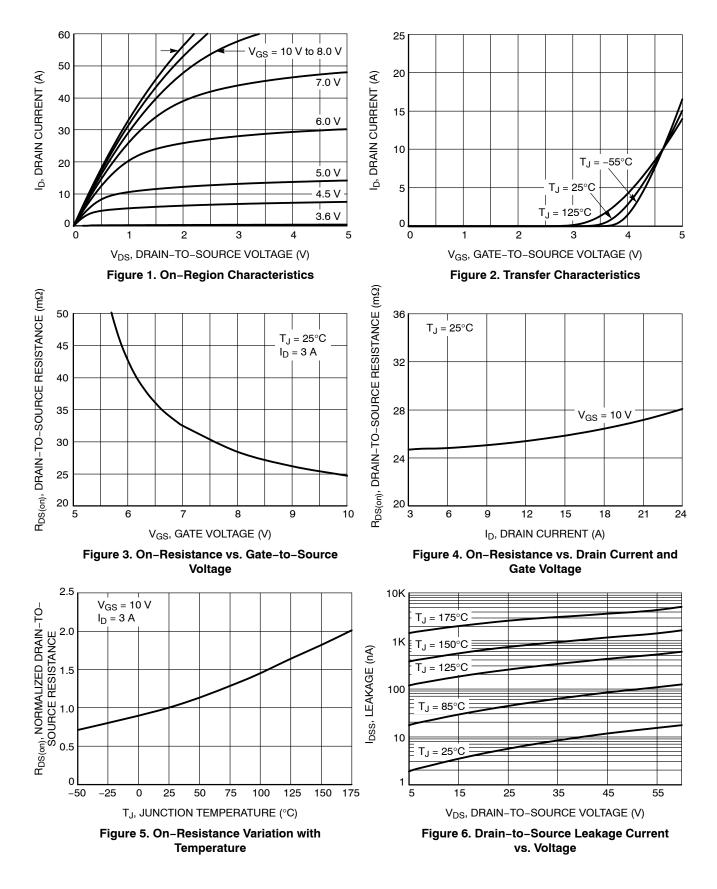
Parameter	Symbol	Мах	Unit	
Junction-to-Case - Steady State (Note 2)	R _{θJC} 6.3		°C M/	
Junction-to-Ambient - Steady State (Note 2)	R _{0JA}	46.6	°C/W	

ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise specified)

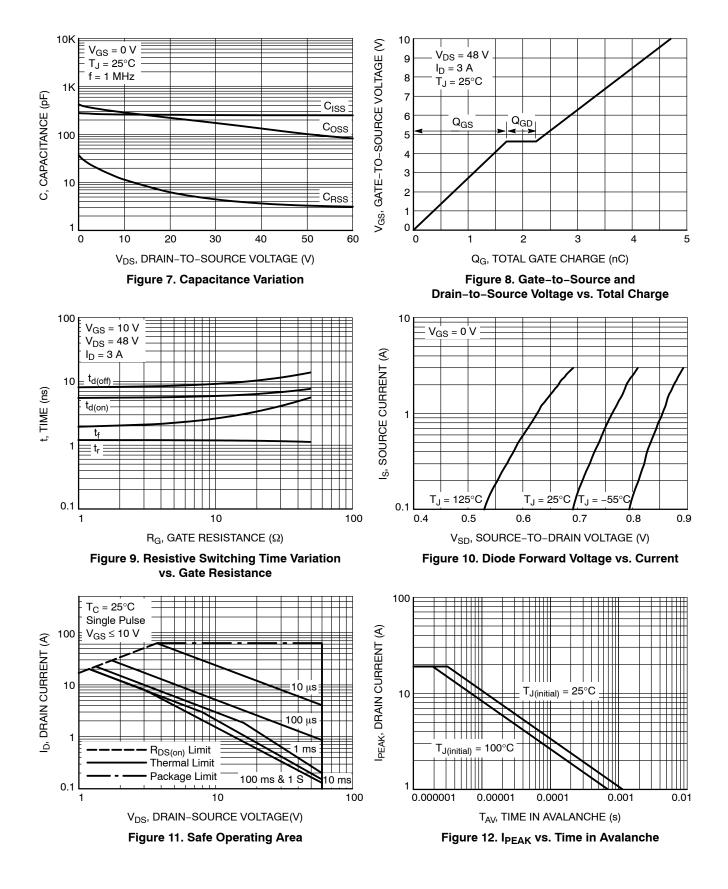
Parameter	Symbol	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS	•I						•
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V_{GS} = 0 V, I_D = 250 μ A		60			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} / T _J	$I_D = 250 \ \mu\text{A}, \text{ ref to } 25^\circ\text{C}$			-7.9		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	$V_{GS} = 0 V,$ $T_{J} = 25^{\circ}C$				10	μΑ
		$V_{DS} = 60 \text{ V}$ $T_{J} = 125^{\circ}\text{C}$			250		
Gate-to-Source Leakage Current	I _{GSS}	V _{DS} = 0 V, V _{GS} = 20 V				100	nA
ON CHARACTERISTICS (Note 3)							
Gate Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}, I_D = 13 \ \mu A$		2.0		4.0	V
Negative Threshold Temperature Coefficient	V _{GS(TH)} / T _J	$I_D = 13 \ \mu\text{A}$, ref to 25°C			-7.8		mV/°C
Drain-to-Source On Resistance	R _{DS(on)}	$V_{GS} = 10 \text{ V}, \ \text{I}_{D} = 3 \text{ A}$			24.7	29.7	mΩ
Forward Transconductance	g fs	V _{DS} = 5 V, I _D = 3 A			8.5		S
Gate Resistance	R _G	$T_A = 25^{\circ}C$			1.5		Ω
CHARGES & CAPACITANCES							
Input Capacitance	C _{ISS}	V _{GS} = 0 V, f = 1 MHz, V _{DS} = 30 V			255		pF
Output Capacitance	C _{OSS}				173		
Reverse Capacitance	C _{RSS}				4.4		
Total Gate Charge	Q _{G(TOT)}	V_{GS} = 10 V, V_{DS} = 48 V, I_{D} = 3 A			4.7		nC
Threshold Gate Charge	Q _{G(TH)}				1.1		-
Gate-to-Source Charge	Q _{GS}				1.7		
Gate-to-Drain Charge	Q _{GD}				0.54		
SWITCHING CHARACTERISTICS (Not	e 3)						
Turn-On Delay Time	t _{d(ON)}				5.7		ns
Rise Time	t _r	V _{GS} = 10 V,	V _{DS} = 48 V,		1.2]
Turn-Off Delay Time	t _{d(OFF)}	$I_D = 3A, R_G = 6 \Omega$			8.7		
Fall Time	t _f				2.3		
DRAIN-SOURCE DIODE CHARACTER	RISTICS						
Forward Voltage V _{SD}	V _{SD}	$V_{GS} = 0 V,$ $I_{S} = 3 A$	$T_{\rm J} = 25^{\circ} \rm C$		0.82	1.2	V
			T _J = 125°C		0.68		
Reverse Recovery Time	t _{RR}	V_{GS} = 0 V, d _{IS} /d _t = 100 A/µs, V _{DS} = 30 V, I _S = 3 A			21		ns
Charge Time	ta				11		
Discharge Time	tb				10		
Reverse Recovery Charge	Q _{RR}				9.7		nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS

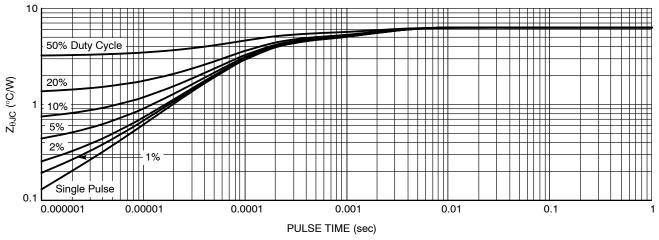


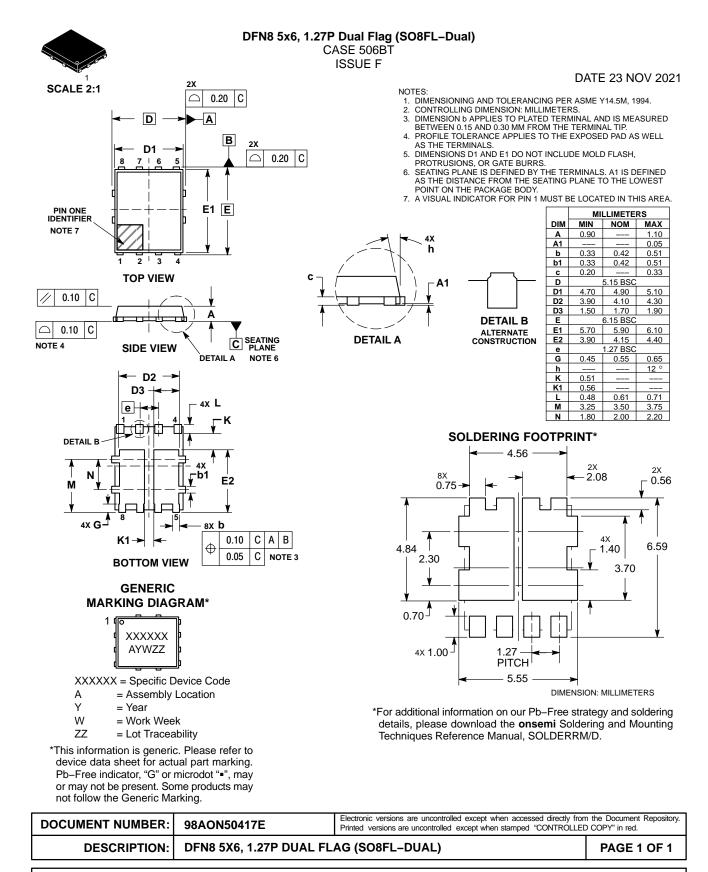
Figure 13. Thermal Response

DEVICE ORDERING INFORMATION

Device	Marking	Package	Shipping [†]
NVMFD030N06CT1G	30DN6C	SO-8FL Dual (Pb-Free)	1500 / Tape & Reel
NVMFWD030N06CT1G	30DN6W	SO-8FL Dual (Pb-Free, Wettable Flanks)	1500 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

onsemi



onsemi and ONSEMI are trademarks of Semiconductor Components Industries, LLC dba onsemi or its subsidiaries in the United States and/or other countries. onsemi reserves the right to make changes without further notice to any products herein. onsemi makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. onsemi does not convey any license under its patent rights of others.

onsemi, ONSEMI, and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries. onsemi owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of onsemi's product/patent coverage may be accessed at <u>www.onsemi.com/site/pdf/Patent_Marking.pdf</u>. onsemi reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and onsemi makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or indental damages. Buyer is responsible for its products and applications using onsemi products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by onsemi. "Typical" parameters which may be provided in onsemi data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. onsemi does not convey any license under any of its intellectual property rights nor the rights of others. onsemi products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification. Buyer shall indemnify and hold onsemi and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs,

ADDITIONAL INFORMATION

TECHNICAL PUBLICATIONS:

Technical Library: www.onsemi.com/design/resources/technical-documentation onsemi Website: www.onsemi.com

ONLINE SUPPORT: <u>www.onsemi.com/support</u> For additional information, please contact your local Sales Representative at <u>www.onsemi.com/support/sales</u>